

Electronic Patent Application Fee Transmittal				
Application Number:		10586908		
Filing Date:		24-Jul-2006		
Title of Invention:		WIRING DESIGN SUPPORT APPARATUS FOR BOND WIRE OF SEMICONDUCTOR DEVICES		
First Named Inventor/Applicant Name:		Akihiro Goto		
Filer:		James A. LaBarre/Mary Alice Smith		
Attorney Docket Number:		1032404-000154		
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